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1 **Limited Enhancement of Subatmospheric Boiling on Treated**  
2 **Structured Surfaces with Biphilic Pattern**

3

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31 **Abstract**

32 Boiling heat transfer suffers deteriorations under subatmospheric conditions, which can  
33 be attributed to a shortage of viable nucleation sites at declining pressures. In this work,  
34 the possibility of enhancing low-pressure saturated boiling of water using a combination  
35 of wettability patterning and structural modifications was experimentally explored. The  
36 copper test surface, comprised of an array of circular “dimples” (0.3 mm in depth, 0.5  
37 mm in diameter, and 3.0 mm in pitch), was spray-coated by PTFE  
38 (polytetrafluoroethylene) coatings so as to form a matching biphilic pattern with the  
39 surface cavities. The resulting dimpled biphilic surface showed appreciable heat transfer  
40 enhancement—with a maximum 60% increase of the average heat transfer coefficient of  
41 nucleate boiling compared with a flat biphilic surface—down to about 9.5 kPa. Further  
42 lowering the pressure to 7.8 kPa, however, was found to lead to diminished performance  
43 gains. The visualization study of the bubble departure dynamics revealed signs of  
44 additional vapor trapping of the hydrophobic-coated cavities, which can induce  
45 uninterrupted bubble regeneration with zero waiting time and explain the qualified  
46 enhancement of subatmospheric boiling. Thanks to a potential secondary pinning of  
47 contact line inside the hydrophobic cavities, incomplete bubble detachment could prevail  
48 at somewhat lower pressures than was otherwise possible without the dimple structure,  
49 leaving behind significantly more vapor residues. However, the vapor trapping capacity  
50 was found to decrease with pressure, which provided clues with regard to the reduced  
51 efficacy of the surface at even lower pressures.

## 52 Nomenclature

- 53  $a$  = slope of linear fit of the temperature distribution, °C/mm
- 54  $b$  = intercept of linear fit of the temperature distribution, °C
- 55  $C$  = constants used in empirical correlations Eqs. (1) and (2)
- 56  $c_p$  = specific heat at constant pressure, kJ/kg K
- 57  $D_b$  = bubble diameter at departure, mm
- 58  $g$  = gravitational acceleration, m/s<sup>2</sup>
- 59  $H$  = water height, mm
- 60  $h$  = heat transfer coefficient, kW/m<sup>2</sup> K
- 61  $h_{lv}$  = latent heat of vaporization, kJ/kg
- 62  $Ja$  = Jakob number
- 63  $L$  = cavity diameter, mm
- 64  $m$  = constant in Eq. (3)
- 65  $n$  = constant in Eq. (1)
- 66  $P$  = pressure, kPa
- 67  $P^*$  = threshold pressure as defined by Eq. (10) and Eq. (11), kPa
- 68  $Pr$  = Prandtl number
- 69  $p$  = pitch, mm
- 70  $q$  = heat flux, kW/m<sup>2</sup>
- 71  $Ra$  = surface roughness, μm
- 72  $T_i$  = temperature measurements by heater thermocouples ( $i=1, 2,$  and  $3$ ), °C



73  $\Delta T_{sat}$  = surface superheat, K

74  $x_i$  = locations of the heater thermocouples ( $i=1, 2,$  and  $3$ ), mm

75  $z$  = cavity depth, mm

76

77 **Greek letters**

78  $\alpha$  = thermal diffusivity,  $m^2/s$

79  $\beta$  = static contact angle,  $^\circ$

80  $\delta$  = uncertainty

81  $\lambda$  = thermal conductivity, W/m K

82  $\mu$  = dynamic viscosity,  $\mu Pa \cdot s$

83  $\rho$  = density,  $kg/m^3$

84  $\sigma$  = surface tension, mN/m

85

86 **Subscripts**

87  $b$  = bulk fluid

88  $c$  = copper heat transfer block

89  $L$  = the Levy correlation

90  $l$  = liquid

91  $ONB$  = onset of nucleate boiling

92  $R$  = the Rohsenow correlation

93  $sat$  = saturated state

94  $v$  = vapor

95  $w$  = test surface

96 **1. Introduction**

97 **1.1 Fundamentals of boiling heat transfer.**

98 Heat is an integral part of modern industry, from power generation to air-conditioning  
99 and refrigeration. How to safely dissipate large amounts of industrial heat without  
100 incurring detrimental temperature excursions raises growing challenges to come up with  
101 novel efficient cooling solutions. In electronics cooling in particular, the demand is even  
102 more urgent as recent advances in miniaturization of computer components continue to  
103 elevate surface heat flux to seemingly untenable levels (projected to exceed 100 W/cm<sup>2</sup>  
104 [1]) that go well beyond the capabilities of conventional fan-cooled heat sinks. Two-  
105 phase cooling schemes such as boiling offer an attractive alternative to keep computer  
106 chip temperature low when continuously removing heat in a reliable and efficient  
107 manner [2]. Boiling heat transfer, by tapping into the vast reservoir of latent heat of  
108 vaporization, has the potential to provide heat transfer rates that can be orders-of-  
109 magnitude more efficient than single-phase heat conduction and convection.

110 Despite the apparent importance of boiling and the intense intellectual interest that it  
111 has stirred in decades past [3,4], the topic still remains a fertile research ground that  
112 seems to have more questions than clear answers. A well-established theory by Hsu [5]  
113 has heterogeneous boiling started when a bubble manages to emerge from vapor nuclei  
114 embedded in surface defects and scratches (of certain critical sizes) and moves on to  
115 grow in a sufficiently superheated liquid layer. Such onset of nucleate boiling (ONB) is

116 marked by a sharp departure from the mode of single-phase convection on the typical  
117 boiling curve that depicts the relationship between surface heat flux  $q$  and wall  
118 superheat  $\Delta T_{sat}$ . In this physical scenario, bubble nucleation relies exclusively upon the  
119 presence of trapped gas and vapor [6] and the availability of properly sized cavities [7].  
120 The former has to do with the initial wetting state of the surface, in which, based on  
121 Bankoff's simple model [8], the advancing contact angle plays a vital role. Air trapping,  
122 however, might be subject to long-term volatility as air tends to gradually diffuse into  
123 the surrounding liquid, thus leading to the eventual flooding of the whole surface [7],  
124 which can partially explain the wide gap between actual ONB measurements and  
125 theoretical predictions [9] and the 'aging' effect that undermines the efficacy of most  
126 surface enhancement techniques [10]. The latter criterion regarding cavity size is  
127 currently facing mounting scrutiny as new experimental evidence brings to the fore  
128 questions about its physical validity. Nam et al. [11] obtained unexpectedly low ONB  
129 superheats ( $\Delta T_{ONB}=3$  K) in boiling of degassed water on a Teflon-coated hydrophobic  
130 silicon substrate that was supposedly cavity-free with a root-mean-squared (RMS)  
131 roughness less than 1 nm. Qi and Klausner [12] measured the active nucleation site  
132 density in heterogeneous boiling of highly wetting ethanol on nominally smooth and  
133 coarse surfaces, which, surprisingly, showed nearly identical results. Perplexed by the  
134 findings, they went on to propose surface nanobubbles as an alternative mechanism to  
135 the classical vapor-trapping-cavity model.

136 Drawing energy from the heater surface and the surrounding superheated liquid, the  
137 bubble continues to grow and finally detach itself from the surface, which is usually  
138 followed by a finite waiting period such that the nucleation condition can be met to  
139 initiate the next ebullition cycle. Major contributions to the highly efficient heat transfer  
140 during this phase of nucleate boiling include transient heat conduction as a result of  
141 repeated regeneration of a thermal layer swept away by the departing bubbles,  
142 evaporation of a liquid microlayer trapped at the base of an expanding bubble interface,  
143 and enhanced local flow motion (i.e., microconvection). Mikic and Rohsenow [13]  
144 proposed, under the assumption of heat transfer being dominated by heat conduction,  
145 an early correlation for nucleate boiling that requires extensive empirical inputs  
146 including the number of active nucleation sites, bubble departure diameter and  
147 frequency. Yet, according to a wall heat flux partitioning analysis based on numerical  
148 results, the time-integrated contribution of thermal conduction was capped at a  
149 maximum 50% and became relevant only towards the late stages of bubble departure  
150 [14].

151 The significance of microlayer evaporation has long been an area of debate in boiling  
152 research. The pioneering measurement of microlayer formation by Koffman and Plesset  
153 [15] using laser interferometry combined with high-speed photography revealed a typical  
154 microlayer—formed in boiling of subcooled water at atmospheric pressure on a Pyrex  
155 glass surface—to have a wedgelike profile initially about 1.85  $\mu\text{m}$  thick and 0.25 mm

156 wide. Dismissed early on as the least significant amongst the boiling heat transfer  
157 mechanisms [13], evaporation of such a finely-structured layer, as it turns out, involves  
158 complex heat and momentum transport subprocesses. In order to derive an accurate  
159 description[16–18], it requires detailed accounts for the capillary pressure, disjoining  
160 pressure and recoil pressure, which leads ultimately to a fourth-order ordinary  
161 differential equation for the layer thickness. Employing numerical simulations, Stephen  
162 and coworkers [19,20] reached the conclusion that as much as 30% of the total heat  
163 transfer could have passed through the microlayer region prior to the dry-out condition.  
164 Utaka et al. [21] performed simultaneous measurements of the evolving microlayer  
165 structure and the bubble expansion process, and reported that the contribution of  
166 microlayer evaporation was probably in the range of 14-44% for water and around 39%  
167 for ethanol, respectively.

168 It has long been recognized that ‘agitation’ to the liquid caused by oscillations of the  
169 liquid-vapor interface and, to a greater extent, vortical motion formed in the wake of a  
170 departing bubble plays a leading role in improving heat transfer efficiency. Based on a  
171 direct analogy with forced convection (with the dimensionless Reynolds number defined  
172 using the empirical values for the mass velocity and size of the bubble leaving the  
173 surface), Rohsenow [22] proposed one of the most acclaimed correlations for pool boiling  
174 in 1952,

175 
$$\frac{c_{p,l}\Delta T_{sat}}{h_{lv}} = C_R \left[ \frac{q}{\mu_l h_{lv}} \sqrt{\frac{\sigma}{g(\rho_l - \rho_v)}} \right]^{0.33} \text{Pr}^n \quad (1)$$

176 where  $c_{p,l}$  denotes the liquid specific heat,  $h_{lv}$  the latent heat of vaporization,  $\mu_l$  the  
 177 liquid dynamic viscosity,  $\sigma$  the surface tension,  $g$  the acceleration due to gravity,  $\rho_l$  the  
 178 liquid density,  $\rho_v$  the vapor density, and  $\text{Pr}_l$  the liquid Prandtl number. The constants  
 179  $C_R$  and  $n$  depend on the specific surface-fluid combination [23]. Further modifications to  
 180 the above correlation were made later by Levy [24]—who used analytical prediction for  
 181 the bubble growth rate to define the Reynolds number—so as to curtail its reliance on  
 182 empirical inputs. That effort arrived at

183 
$$q = \frac{1}{C_L} \frac{\lambda_l c_{p,l} \rho_l^2}{\sigma T_{sat} (\rho_l - \rho_v)} \Delta T_{sat}^3 \quad (2)$$

184 where  $C_L$  is a constant determined by experimental data and  $\lambda_l$  the liquid thermal  
 185 conductivity. Note that the well-known  $q \sim \Delta T_{sat}^3$  relation [6] can be recovered explicitly  
 186 in Eq. (2).

187 A recent numerical study by Kandlikar [4] suggests that enhanced evaporation at the  
 188 bubble interface is most likely a secondary effect resulting from microconvection  
 189 entraining superheated liquid from the thermal layer over the rest of the bubble surface.  
 190 For more on the mechanistic descriptions of boiling heat transfer, the reader is referred  
 191 to the superb reviews by Dhir et al. [14] and Kim [25].

192 As the surface heat flux continues to rise, the isolated-bubble regime is quickly taken  
193 over, due to increasing bubble coalescence, by formation of massive structures like vapor  
194 columns and mushrooms (with stems extending to the surface), and finally by that of  
195 vapor patches (i.e., local film boiling) [26]. Through numerical simulations, Dhir et al.  
196 showed that vertical merger between successive bubbles ejected from the same  
197 nucleation site contributed little to heat transfer [27] while, by contrast, lateral merger  
198 of bubbles from neighboring sites could lead to formation of vapor bridges with liquid  
199 trapped underneath, whose evaporation was able to cause a temporary boost to the  
200 overall wall heat flux [28]. With the surface being increasingly deprived of liquid supply  
201 that fuels sustained nucleation of bubbles, boiling enters a transition to the far less  
202 efficient mode of film boiling [29,30], culminating in a dramatic event called critical heat  
203 flux (CHF). The corresponding *peak* heat flux on the proverbial boiling curve can be  
204 triggered by various mechanisms, including notably the Taylor-Helmholtz instability at  
205 the interface of escaping vapor jets [31] and the dominance of evaporation momentum  
206 force parallel to the heater surface [32,33].

## 207 **1.2 Enhancement of nucleate boiling.**

208 As pointed out by Warriar and Dhir [34], empirical curve-fitting-based correlations of  
209 boiling heat transfer are prone to gross errors, whose predicting power tends to fall  
210 precipitously when applied to situations outside their designed limits, due largely to a  
211 lack of sound physical foundation. Yet the mechanistic approach [6], as a result of its



212 normally narrow scope, also faces challenges of inconsistency as it often fails to take into  
213 account the complex interactions between various relevant subprocesses involved in  
214 nucleate boiling. For these reasons, there genuinely is an epistemic divide between the  
215 physical interpretation of boiling and how that knowledge can be used to improve it in  
216 practice. Answers to the latter question, decades of continuous efforts notwithstanding,  
217 are still being sought mostly through trial-and-error measures, which makes boiling heat  
218 transfer enhancement more of an art than an exact science.

219 Increasing surface roughness is one of the most basic techniques to enhance nucleate  
220 boiling. One can create more vapor-trapping cavities simply by roughening the surface,  
221 which would likely have an augmented bubble population (and larger heat transfer area)  
222 and consequently a higher heat transfer coefficient. However, the practice has its  
223 limitations. First, diminished returns with further increasing roughness have been well  
224 documented in experiments. Jones et al. [35] reported little improvement to the heat  
225 transfer coefficient of pool boiling of water on test surfaces modified by electrical charge  
226 machining beyond a threshold around  $1.08\ \mu\text{m}$ ; Kim et al. [36] found CHF to rise before  
227 plateauing with increasing roughness of superhydrophilic aluminum surfaces, in spite of  
228 the apparently augmented capillary wicking due to the formation of nanoscale-  
229 protrusion structures. Second, cavities formed by scuffing and roughening the surface are  
230 known to be vulnerable to *flooding* (by highly-wetting fluids in particular) [6,7], which  
231 contributes to the long-term performance degradation known as ‘the aging effect’ [10].

232 In order to build more stable vapor traps, multiple studies have been devoted to designs  
233 of reentrant-type surfaces with complicated three-dimensional structures. The famous  
234 ‘pore-and-tunnel’ surface geometry [37], for instance, helps significantly enhance (latent)  
235 heat transfer by continuously drawing liquid through the open pores in the surface into  
236 the interconnected tunnel space underneath, where it comes into contact with heated  
237 surface over a larger area and quickly evaporates [10]. Li and Peterson [38] developed  
238 microporous boiling surfaces by sintering multilayer isotropic copper wire screens. The  
239 fused meshes formed the highly conductive skeleton of the porous media, via which heat  
240 could be transported more efficiently to the numerous nucleation sites on the surface.  
241 Interestingly, they noted that the seemingly dry-out condition inside the porous  
242 structure did not automatically trigger CHF, thanks to an alternative route somehow  
243 opened up for vapor escape through the unsealed sides of the coating. More direct  
244 manipulation of vapor and liquid pathways were attempted by use of microchannel  
245 surfaces [39] and bi-conductive surfaces [40]. Surface wettability patterning in particular  
246 has emerged as one of the most promising ways to actively manipulate bubble behavior.  
247 In general terms, hydrophobic surfaces (with a contact angle  $\beta > 90^\circ$ ) promote bubble  
248 formation while liquid wetting is facilitated if the surface is hydrophilic ( $\beta < 90^\circ$ ). A  
249 hybrid surface endowed with these two opposing topographical characteristics is capable  
250 of bringing about a higher degree of control over bubble growth and spreading in  
251 nucleate boiling, which can be optimized to achieve more effective boiling heat transfer  
252 [41]. Betz et al. [42] first discovered that the maximum heat flux and heat transfer

253 coefficient of saturated boiling of water could be enhanced, respectively, by a significant  
254 margin of 65% and 100% when a non-connected network of Teflon hydrophobic  
255 hexagonal patterns were deposited on a hydrophilic silicon wafer. (Such surface feature  
256 has since been coined *biphilicity*). Aside from spatially juxtapositions of wettability  
257 patterns, Frankiewicz and Attinger [43] raised an interesting concept of *temporal*  
258 *biphilicity* where reversible switches between the hydrophilic Wenzel state and the  
259 hydrophobic Cassie-Baxter state could be made by special repeated protocols of  
260 overheating and pressurization of the surface.

261 One often overlooked feature of biphilic surfaces has to do with the ease with which  
262 bubbles get nucleated [44]. It has long been established that wettability is a singularly  
263 important surface parameter affecting bubble nucleation. Wang and Dhir [45] found that  
264 a decrease from  $\beta=90^\circ$  to  $18^\circ$  (caused by oxidation of the test copper surface) resulted in  
265 over a 90% drop in the active site density and noticeably lower heat transfer rates. The  
266 exceptionally low ONB, along with essentially no waiting time, of hydrophobic surfaces  
267 [11] proved to be of great asset to boiling at subatmospheric pressures, which could be  
268 particularly susceptible to debilitating performance deterioration known as intermittent  
269 boiling (even on enhanced microchannel surfaces [2]). We previously studied low-  
270 pressure boiling on flat biphilic surfaces that were electroplated with hydrophobic nickel  
271 and TFEO (tetrafluoroethylene oligomer) spots [46]. The results showed that the  
272 transition to the regime of intermittent boiling was effectively delayed—owing to the

273 robustness of nucleation sites to pressure reductions as a result of strong pinning of the  
274 bubble contact line [47]—but not completely eliminated. The objective of the present  
275 study is to explore the possibility of inducing greater enhancement of nucleate boiling at  
276 very low pressures on biphilic surfaces by means of incorporating cavity structures. The  
277 results show that surface ‘dimples’ overlapping with hydrophobic patterns can provide  
278 much stable traps for vapor residues and act as more reliable nucleation sites than flat  
279 biphilic surfaces.

## 280 **2. Experimental setup**

### 281 **2.1 Boiling facility.**

282 A schematic diagram of the boiling test rig is shown in Fig. 1. The Pyrex-glass boiling  
283 vessel had an inner diameter of 120 mm and a height of 450 mm. The top plate of the  
284 vessel consisted of ports for a pressure gauge and a K-type thermocouple (1.0 mm in  
285 diameter) that were employed to measure the pressure and pool temperature,  
286 respectively. A thermodynamically saturated state of the bulk working fluid—deionized  
287 pure water in this case—was maintained during experiments by manually adjusting two  
288 coil heaters (powered by variable voltage transformers) and an internal cooler  
289 (connected to a constant-temperature water chiller, with a maximum cooling power of  
290 360W). The vessel itself was placed in a case made of Styrofoam (with a glass window  
291 installed for visualization purposes). A PID-regulated air heater (with a maximum

292 output of 0.14 m<sup>3</sup>/min@600 °C) was relied on to mitigate any potential heat losses to  
293 the environment.

294 The vessel bottom was attached to the heater assembly that contained an ø30-mm  
295 copper heat transfer block (about 100 mm long). Wrapped in glass wool insulation, the  
296 heat transfer block had a tapered lower body (for mounting ease). The upper-facing  
297 surface of the block was used as the test surface, which was widened to include a thin  
298 (0.3 mm) 50-mm-wide ring so as to effectively suppress unwanted bubble nucleation at  
299 the edges. The installation of the block was secured by an O-ring, and adhesive silicon  
300 RTV sealant was applied at the groove between the ringed surface and the stainless  
301 casing—and allowed to cure overnight—before each experimental run. Two sheath  
302 heaters (with a maximum power of 700 W each) were embedded in the copper base of  
303 the heater assembly to provide a continuous heat load to the heater surface. Minimal  
304 (radial) heat losses were deemed for one-dimensional heat conduction to prevail along  
305 the heat transfer block. Three ø1.0-mm K-type thermocouples (with a measurement  
306 error of ±0.12 K according to the data sheet provided by the manufacturer) were placed  
307 along the centerline of the heat transfer block, respectively, at  $x_1=3.9$  mm,  $x_2=8.3$  mm,  
308 and  $x_3=12.8$  mm from the top test surface, whose readings were relied on to generate an  
309 accurate axial temperature profile. The corresponding thermocouple signals  $T_1$ ,  $T_2$ , and  
310  $T_3$ , along with the bulk temperature measurement  $T_b$ , were recorded by a Data

311 Acquisition system at a sampling rate of  $5\text{ s}^{-1}$ . More technical details about the  
312 experimental setup can be found in our previous work [47].

## 313 **2.2 Test surfaces.**

314 Surfaces with overlapping wettability and cavity patterns were fabricated taking the  
315 following steps (see Fig. 2(a)). First, the top of the heat transfer block was polished to a  
316 mirror finish ( $Ra \approx 0.03\text{ }\mu\text{m}$ , using grit 600 emery paper and then buffing with  $3.0\text{ }\mu\text{m}$   
317 and  $1.0\text{ }\mu\text{m}$  abrasive alumina compounds). Next, an array of ‘dimples’ were drilled onto  
318 the surface using a computer-aided precision desktop mill. The machined circular  
319 cavities, formed in a uniform unstaggered array of pitch  $p = 3.0 \pm 0.01\text{ mm}$  (see Fig. 2(b)),  
320 all had the same diameter  $L = 0.5 \pm 0.01\text{ mm}$  and depth  $z = 0.3 \pm 0.01\text{ mm}$ . The bottom of  
321 the cavities was mostly flat with a roughness about  $Ra \approx 4.4\text{ }\mu\text{m}$ , as shown in Fig. 2(c).

322 After being washed in an ultrasonic bath of acetone, the surface cavities were spray-  
323 coated with hydrophobic PTFE (polytetrafluoroethylene) coating, with the aid of  
324 masking tape (Fig. 2(a)). The coating robustness was increased by the thermal  
325 treatment of baking the surface in an oven filled with nitrogen gas (so as to prevent  
326 oxidation) at  $260\text{ }^\circ\text{C}$  for over 30 minutes. The coated cavities featured a slightly  
327 elevated roughness of  $Ra \approx 5.1\text{ }\mu\text{m}$  (see Fig. 2(c)), which, along with the increased  
328 contact angle  $\beta > 120^\circ$  (vs.  $\beta \approx 80^\circ$  for the uncoated copper surface), makes for preferred  
329 sites for bubble nucleation. It should be noted that due to the low thermal conductivity  
330 of PTFE (around  $0.25\text{ W/m K}$ ), a significant temperature drop could potentially take

331 place, reaching 2.5 K for a 6.4- $\mu\text{m}$  [47] coating layer under a moderate surface heat flux  
332 of  $q=100\text{ kW/m}^2$ . To investigate the effect of the cavity array, we have also prepared a  
333 *flat* biphilic with an identical wetting pattern (namely, comprised of hydrophobic spots  
334 0.5 mm in diameter and 3.0 mm in pitch).

### 335 **2.3 Experimental procedure.**

336 Deionized pure water was filled through the lower inlet opening (Fig. 1) into the boiling  
337 vessel that was evacuated by a vacuum pump, until the water reached a set height of  
338  $H=120.0\pm 1.0$  mm above the heater surface. Prior to the experimental, purging the  
339 water of incondensable gas was performed by continuous vacuum deaeration for over 2  
340 hours. From this point forward, the vessel was closed off from the atmosphere. The bulk  
341 temperature (and pressure) was allowed to gradually increase by turning on the  
342 auxiliary bulk heaters. As the readings from the pressure gauge and the pool  
343 thermocouple approached their respective target values, the power outputs of the  
344 heaters were carefully adjusted to stabilize the bulk pressure and temperature. During  
345 the experiment, the internal cooler was also used to maintain a constant background of  
346 thermal equilibrium. The experiment commenced when the fluctuations of  $T_b$  remained  
347 less than 0.5  $^{\circ}\text{C}$  over a period of 200 seconds.

348 We set out to study heat transfer of saturated nucleate boiling at different pressure  
349 levels. As Table 1 shows, the thermophysical properties of water experience significant  
350 variations with decreasing pressure [48], especially in the cases of  $\mu_l$  and  $\text{Pr}_l$ . According

351 to Eq. (1), boiling heat transfer can thus be expected to appreciably deteriorate under  
352 subatmospheric pressures. Also contributing (indirectly) to the poor performance is the  
353 markedly lower vapor density  $\rho_v$ , which has been found to lead to unstable *intermittent*  
354 bubble nucleation events [46,47].

355 Experiments were conducted with stepwise increasing heat flux at the boiling surface  
356 under the same saturated pressure. At least 20 minutes were allowed to elapse between  
357 measurements in order to guarantee that the boiling process would reach a steady state.  
358 It is noted that all the experimental runs were terminated before CHF was triggered to  
359 avoid damages to the test surface. Also, the potential effect of boiling hysteresis was not  
360 examined in the present study since no significant temperature overshoot associated  
361 with the onset of boiling was observed (all thanks to the apparently facilitated bubble  
362 nucleation on the hydrophobic-coated surfaces [44]).

#### 363 **2.4 Data reductions.**

364 The temperature readings of the embedded thermocouples  $T_1$ ,  $T_2$ , and  $T_3$ —averaged  
365 over a period of 2 minutes (with limited fluctuations  $< 0.25$  K)—are relied on to provide  
366 a measure of steady-state heat transfer of nucleate boiling. Under the assumption of  
367 predominant Fourier heat conduction, simple least squares regression analysis leads to a  
368 temperature profile along the heat transfer block,  $T(x) = ax + b$ , where  $a$  and  $b$  are the fit  
369 parameters. Hence, the surface heat flux can be calculated as



370

$$\begin{aligned}
 q &= \lambda_c a \\
 &= \lambda_c \frac{3 \sum x_i T_i - \sum x_i \sum T_i}{3 \sum x_i^2 - (\sum x_i)^2}
 \end{aligned}
 \tag{3}$$

371 where the copper thermal conductivity exhibits a temperature dependence as  
 372  $\lambda_c = 399.1688 - 4.2986 \times 10^{-2} \times \bar{T} - 2.0756 \times 10^{-5} \times \bar{T}^2$  (in W/m K), with the overbar representing  
 373 the average temperature of  $T_1$ ,  $T_2$  and  $T_3$ . The surface temperature, on the other hand,  
 374 is directly extrapolated from the linear relation,

375

$$\begin{aligned}
 T_w &= b \\
 &= \frac{1}{3} (\sum T_i - a \sum x_i)
 \end{aligned}
 \tag{4}$$

376 As for the superheat, the following definition is used

377

$$\begin{aligned}
 \Delta T_{sat} &= T_w - T_{sat}(P_w) \\
 &= T_w - T_{sat}(P_b + \rho_l g H)
 \end{aligned}
 \tag{5}$$

378 Note that given that hydrostatic pressure could become potentially significant under low  
 379 pressures, the saturation temperature is evaluated at the heater surface. Here  $P_b$   
 380 represents the system pressure measured by the pressure gauge (with a measurement  
 381 error around 400 Pa). In the following, without otherwise specified,  $P$  is referred to as  
 382 the pressure corrected for the hydrostatic pressure contribution. The heat transfer  
 383 coefficient is simply given as

384

$$h = \frac{q}{\Delta T_{sat}}
 \tag{6}$$

385 The uncertainty analysis is conducted following the principle of error propagation, which  
 386 ultimately arrives at

$$387 \quad \delta(q) = \sqrt{\left(\frac{\partial q}{\partial \lambda_c} \delta(\lambda_c)\right)^2 + \left(\frac{\partial q}{\partial a} \delta(a)\right)^2} \quad (7)$$

$$388 \quad \delta(\Delta T_{sat}) = \sqrt{\left(\frac{\partial \Delta T_{sat}}{\partial b} \delta(b)\right)^2 + \left(\frac{\partial \Delta T_{sat}}{\partial P_b} \delta(P_b)\right)^2} \quad (8)$$

389 for the heat flux and superheat, respectively. Figure S1 in Supplemental Material plots a  
 390 data collection of the relative uncertainties  $\delta(q)/q$ ,  $\delta(\Delta T_{sat})/\Delta T_{sat}$ , and  $\delta(h)/h$ . All the  
 391 results are estimated at 68 percent confidence level. It is made clear that with the  
 392 exception of a couple of data points in the low-heat-flux region, most of the  
 393 measurements are reasonably accurate, within 20% in the case of  $q$  and 10% of  $\Delta T_{sat}$ ,  
 394 respectively. Similarly, the uncertainty for the heat transfer coefficient is evaluated using

$$395 \quad \delta(h) = \sqrt{\left(\frac{\partial h}{\partial q} \delta(q)\right)^2 + \left(\frac{\partial h}{\partial \Delta T_{sat}} \delta(\Delta T_{sat})\right)^2} \quad (9)$$

396 which is below 15% in the region of nucleate boiling.

### 397 **3. Results**

#### 398 **3.1 Plain surface.**

399 In Fig. 3 we plot the boiling curves obtained for a plain smooth copper surface at two  
 400 differing pressure levels of  $P=101.3$  kPa (blue square) and 9.1 kPa (black circle). Also  
 401 included in the figure are predictions based on Rohsenow's correlation (Eq. (1)), with  
 402 the parameters  $C_R=0.015$  and  $n=1.0$  (chosen for the fluid-surface combination of water

403 and circular copper plate [23]). The present experiment results show generally good  
404 agreement with the correlation. Once boiling is initiated on the plain surface, the curve  
405 for  $P=9.1$  kPa quickly trends upwards before settling within a deviation of 10% of the  
406 empirical correlation, whereas the difference grows somewhat, to about 20% for  $P=101.3$   
407 kPa. Both the experiment results and the correlation demonstrate a significant  
408 deterioration of heat transfer due to the pressure decrease. The unmistakable rightward  
409 shift of the boiling curve is accompanied by an even greater jump (over 10 K) in ONB  
410 superheat, which could be largely attributed to a dearth of properly sized cavities on the  
411 surface that are able to accommodate the increasingly larger bubbles under reduced  
412 pressures [5].

### 413 **3.2 Flat biphilic surface.**

414 Figure 4 shows the boiling curves for the *flat* biphilic surface under the particularly low  
415 pressures of  $P=14.3$  kPa (black circle), 9.5 kPa (blue triangle), and 7.8 kPa (red  
416 square). (For the sake of brevity, only experimental data subsequent to ONB are  
417 included.) Independent of pressure level, nucleate boiling is found to be generally more  
418 efficient in transporting heat on the wettability-patterned surface, which follows the  
419 same pattern of behavior as in our previous study [46]. A clear trend emerges, however,  
420 that the boiling enhancement turns less significant at lower pressures, as indicated by  
421 the visible shift of the boiling curves to the right. As was elucidated in [47], the  
422 lessening effectiveness of the biphilic surface when pressures decreases sufficiently low

423 might have to do with deactivation of nucleation sites due to flooding of the  
424 hydrophobic spots, which has been known to occur more frequently under reduced  
425 pressures.

426 Moreover, it is worth noting that the enhancement appears to also be more pronounced  
427 in the low to middling heat-flux range. As shown in Fig. 5, the ratio of the heat transfer  
428 coefficient  $h$  to that based on the Rohsenow correlation (Eq. 1),  $h_R$ , reaches as high as  
429 1.74 in the case of  $P=14.3$  kPa when boiling is initiated. With increasing  $q$ , however, the  
430 gains in the heat transfer efficiency become less impressive, even falling below the  
431 baseline  $h_R$  for  $P=14.3$  and 9.5 kPa towards the end of the range of heat flux in  
432 question. Such uneven enhancement of boiling heat transfer could be partially ascribed  
433 to the very manner that boiling enhancement comes to be in the first place. Boiling on  
434 the biphilic surface, because of the hydrophobicity-induced favorable condition for  
435 ebullition, is likely to feature a large bubble population (and high heat transfer rates as  
436 a result) even at very low heat fluxes, which depends closely on the specific biphilic  
437 pattern itself. The tendency for bubble nucleation to be limited to the hydrophobic part  
438 of the surface, however, could instead prove to be a hinderance under higher heat fluxes  
439 where a greater bubble population is often needed to maintain the high heat transfer  
440 coefficient. The seemingly less significant drop in  $h/h_R$  at the lower pressures (see Fig. 5)  
441 probably results from the already prevalent lack of available nucleation sites on the  
442 surface at all heat flux levels due to the transition to intermittent boiling.

### 443 **3.3 Dimpled biphilic surface.**

444 The incorporation of machined cavity structures on top of the wetting pattern can  
445 engender even greater enhancement of nucleate boiling, as is shown in Fig. 6 which  
446 depicts the boiling curves for the dimpled biphilic surface for the commensurate pressure  
447 conditions  $P=14.4$  kPa (black circle), 9.5 kPa (blue triangle), and 7.8 kPa (red square).  
448 The gap between the experimental and the empirical results are found to have grown  
449 considerably wider, especially in the case of  $P=14.4$  kPa (cf. Fig. 4). The average ratio  
450 of the heat transfer coefficients rises, respectively, to  $h/h_R=1.95$  from 1.22 for  $P=14.4$   
451 kPa and to  $h/h_R=1.59$  from 1.26 for  $P=9.5$  kPa, based on the data shown in Fig. 7. It is  
452 interesting to note that the added benefit of the cavities seems to decline steeply with  
453 decreasing pressure as the average  $h/h_R=1.24$  hardly budges in the case of  $P=7.8$  kPa  
454 (versus  $h/h_R=1.26$  in the flat case, see Fig. 5). In the following section, we will delve  
455 deeper to elucidate the physical mechanism that is responsible for the heat transfer  
456 enhancement.

## 457 **4. Discussion**

### 458 **4.1 Bubble departure dynamics.**

459 Given the relative shallowness ( $z=0.3$  mm) and the limited quantity (76 in total) of the  
460 dimple cavities, the increase of the potential heat transfer area is estimated to be a mere  
461 1.8% compared with the total area of the flat surface and therefore cannot account for  
462 the higher heat transfer coefficients observed. In order to better understand the  
463 differences between the boiling characteristics on the flat and dimpled biphilic surfaces,

464 we conducted additional measurements of bubble dynamics using high-speed imaging  
465 (Vision Research Phantom v4.3 camera equipped with an AF Nikkor 180 mm f/2.8D IF-  
466 ED telephoto lens). Figure 8(a) shows the test surface used for such visualization effort,  
467 which consisted of two PTFE-coated circular cavities of dissimilar depths,  $z_1=1.0\pm 0.01$   
468 mm versus  $z_2=0.5\pm 0.01$  mm (see Fig. 8(b)). They were placed at a distance of 15 mm  
469 apart across the center of the surface such that bubble nucleation and growth at either  
470 site could proceed with minimal interaction with the other. A cavity diameter  
471  $L=1.8\pm 0.01$  mm was chosen for both cavities, which was notably larger than in the heat  
472 transfer experiments so as to provide a clearer view with finer details of bubble  
473 behavior, especially close to the heater surface. For comparison, we also measured the  
474 bubble behavior on a flat surface coated with a single hydrophobic spot with the same  
475 size.

476 The visualization experiments were conducted following the same protocol as in the  
477 previous measurements of boiling heat transfer. Figures 9 and 10 show the high-speed  
478 photos—captured at a frame speed of  $1000\text{ s}^{-1}$ —that depict the critical moments before  
479 and after bubble departure from the flat and dimpled biphilic surfaces, respectively. It is  
480 noted that the heat input to the test surface was varied slightly between measurements,  
481 resulting in an average superheat around  $\Delta T_{sat}=7.9\text{ K}$  in Fig. 9 and  $\Delta T_{sat}=8.4\text{ K}$  in  
482 Fig. 10, respectively.

483 It has been known for some time [11,44] that bubble growth on a hydrophobic surface is  
484 often preceded by nearly unrestrained expansion of the bubble base (to the point where  
485 boiling could easily be overtaken by a quasi-film boiling regime [49]). As shown in Fig.  
486 9(a), at atmospheric pressure ( $P=100.8$  kPa), the footprint of the bubble seems to  
487 envelop the entire hydrophobic-coated surface leading up to its final liftoff, with the  
488 bubble contact line essentially overlapping with the border with the surrounding  
489 hydrophilic copper surface. The sequence of bubble departure begins with rapid  
490 contraction of its mid-section as the base still remains attached to the surface, which  
491 leads to *necking*—one of the distinct features of bubble dynamics in boiling on  
492 hydrophobic surfaces. The thinning eventually gives rise to a rupture. Most of the  
493 bubble manages to escape due to buoyancy effect while a significant portion is left  
494 behind (marked by yellow rectangle). The residual vapor clinging to the hydrophobic  
495 spot, from which new bubbles are able to emerge with essentially no delay in time, is  
496 arguably one of the key factors in how boiling receives extra boost on biphilic surfaces  
497 [41].

498 At (substantially) subatmospheric pressures ( $P=25.3$  kPa), as shown in Fig. 9 (b), one  
499 critical difference stands out—no residual vapor appears to exist in the aftermath of the  
500 bubble departure. The hydrophobic spot (circled in red) becomes fully ‘exposed’—bare  
501 of any vapor coverage—immediately after the bubble takes off from the surface. The  
502 base of the bubble, whose receding triple-phase contact line seems to have finally given

503 in to the appreciably accelerated bubble expansion [50] to be completely dislodged from  
504 its pinned location at the edge of the hydrophobic area, finds itself being swept away  
505 along with the rest of the departing bubble. As a direct impact of the elimination of  
506 vapor residues, bubble re-nucleation from the flooded hydrophobic spot now entails slow  
507 reformation of the superheated liquid layer, in much the same way as what would occur  
508 on an uncoated plain surface. The resulting nonzero waiting time is believed to be  
509 responsible for the particularly subdued boiling under the low-pressure conditions (see  
510 Fig. 5) that barely performed above the empirical prediction.

511 In the case of the dimpled biphilic surface, on the other hand, a more consistent pattern  
512 of bubble departure dynamics emerges between the two pressures of  $P=101.4$  kPa and  
513 25.4 kPa. As is evidenced by Fig. 10(b), under a similar reduction of pressure as in the  
514 previous flat case, the hydrophobic-coated cavities still manage to retain residual vapor  
515 post departure (albeit in appreciably smaller amounts compared with Fig. 10(a)). One of  
516 the consequences of combining cavity structure with surface hydrophobization, as the  
517 results indicate, is to create substantially stronger traps for vapor that can sustain in  
518 the event of bubble departure at low pressures. We further argue that the dimpled  
519 hydrophobic spots—kept ‘dry’ constantly—provide significantly more stable sites for  
520 *continuous* cyclic bubble regeneration than flat hydrophobic spots, which is deemed to  
521 be a major driver responsible for the enhanced heat transfer rates shown in Fig. 7.  
522 (Incidentally, it would seem that the cavity depth plays no vital role in affecting bubble



523 dynamics because little difference can actually be discerned between the results for  
524  $z_1=1.0$  mm and  $z_2=0.5$  mm. That appears to be the case, at least, for the limited data  
525 available here. It goes without saying that more experiments are needed to derive a  
526 more definitive account of the effect.) In the next section, we seek more quantitative  
527 evidence of such enhanced trapping of vapor.

#### 528 **4.2. Secondary pinning of contact line.**

529 Figure 11 represents a plot depicting the distribution over different pressures of the  
530 departure diameter  $D_b$ —which was measured by averaging the long and short axes of  
531 the departing bubble—of bubbles growing on the flat hydrophobic spot ( $L=1.8$  mm)  
532 under the consistent superheating  $\Delta T_{sat}= 7.9$  K. Each data point (black circle)  
533 represents the median value derived from the measurements of at least eight individual  
534 bubbles, with error bars denoting the spread of the data set (namely, the maximum and  
535 minimum values of the data set). It can be seen from the figure that with decreasing  
536 pressure,  $D_b$  exhibits an interesting transition from staying mostly constant to  
537 embarking on a path leading to a sudden divergence (which is also accompanied by a  
538 proliferation of size fluctuations).

539 The changing behavior can be best described as a fundamental shift in bubble departure  
540 mechanics, in which contact-line dynamics plays the crucial role. Under the assumption  
541 of the contact line remaining pinned on the surface throughout the process of bubble

542 departure, the force balance between the driving buoyancy force and the opposing  
543 surface tension force would give rise to a critical bubble size at departure in the form of

$$544 \quad D_b = \left[ \frac{6\sigma L}{g(\rho_l - \rho_v)} \right]^{1/3} \quad (10)$$

545 (Note that the size of the bubble base is taken to be the same as that of the  
546 hydrophobic spot.) The results by Eq. (10), represented by the solid line in Fig. 11, are  
547 shown to be nearly independent of pressure variations.

548 On the other hand, in the scenario that the contact line (namely, the bubble base) is  
549 allowed to freely contract as it faces little resistance from any potential surface  
550 heterogeneities, bubble departure would most likely depend on how much hydrodynamic  
551 drag the ascending bubble needs to overcome. That leads to a quite different formula for  
552 the departure diameter,

$$553 \quad D_b = \left[ \frac{9\rho_l\alpha_l}{8\pi g(\rho_l - \rho_v)} \right]^{0.5} \frac{\rho_l c_{pl} \Delta T_{sat}}{h_v \rho_v} \quad (11)$$

554 where  $\alpha_l$  is the liquid thermal diffusivity. In sharp contrast to Eq. (10), the above  
555 equation predicts  $D_b$  to be strongly dependent on pressure (see the dot-dash line in Fig.  
556 11). Details about the derivations of these two models can be found in [47].

557 Equations (10) and (11) portray two opposite cases of bubble departure under the  
558 influence of contact-line dynamics, which seems to capture reasonably well the evolution

559 of the measured  $D_b$  over pressure. This encouraging agreement lends support to our  
560 interpretation of how the bubble departure process on the flat biphilic surface varies  
561 with pressure. To summarize, as shown in Fig. 12(a), at relative high pressures, the  
562 expansion of the bubble footprint is mostly limited to the extent of the hydrophobic  
563 spot. Even as the bubble begins to depart the surface, the contact line is still firmly  
564 anchored to the border dividing the hydrophilic and hydrophobic regions, which leads to  
565 incomplete bubble detachment and bubble residues remaining on the hydrophobic  
566 surface. At low pressures (Fig. 12(b)), on the other hand, the weakened pinning of the  
567 contact line allows the bubble base to continuously shrink. Consequently, the bubble of  
568 considerably enlarged size leaves from the surface as a whole, leaving the hydrophobic  
569 spot fully flooded.

570 For bubbles emerging from the hydrophobic-coated cavities, the particular pressure  
571 dependence of  $D_b$  suggests a somewhat different route for bubble departure. In Fig.  
572 13(a) and 13(b) we show the results for the cavities of  $z_1=1.0$  mm and  $z_2=0.5$  mm,  
573 respectively. It can be seen that in both cases, the average size of departing bubbles goes  
574 through two distinct stages—in large part following the pinned-contact-line model (Eq.  
575 (10)) for higher  $P$ , and the depinned-contact-line model (Eq. (11)) for lower  $P$ —in a  
576 similar way as with the flat biphilic surface. What is remarkable about these results is  
577 the apparently delayed transition from the former to the latter. Regardless of the cavity  
578 depth,  $D_b$  manages to stay relatively unchanged at pressure levels as low as about 30

579 kPa. In comparison, for the flat surface with similar biphilic pattern and superheating,  
580 the divergence of  $D_b$  seems to occur around a threshold pressure  $P^*=45.0$  kPa (see Fig.  
581 11) which is defined as the intersection point between the curves by Eq. (10) and Eq.  
582 (11).

583 This extended range of applicability—marked in red in Fig. 13(a) and 13(b)—of the  
584 pinned-contact-line model in describing the event of bubble departure, we argue, is due  
585 to what can be termed “secondary contact-line pinning” inside the hydrophobic cavity.  
586 Since the PTFE coating was applied to both the bottom and side walls of the cavity, it  
587 is reasonable to suspect that underneath a growing bubble, the entire cavity would be  
588 filled with vapor, with the contact line possibly extended as far as the cavity edge. As  
589 shown in Fig. 14(a), when the moment of departure approaches, with the contact line  
590 firmly pinned (at relatively high pressures), we expect the bubble detachment to  
591 progress similarly to that on the flat surface (Fig. 12(a)), which includes namely,  
592 necking to be followed by partial departure of the bubble. When pressure declines below  
593  $P^*$ , the contact line could instead become increasingly prone to receding from its  
594 original position atop the cavity during bubble departure. The hydrophobic nature of  
595 the coated inside of the cavity ( $\beta > 120^\circ$ ), however, is likely to create conditions that  
596 enable trapping of vapor in the corners after the passing of the wetting front, leading to  
597 formation of a new contact line at the bottom of the cavity (see Fig. 14(b)). The latter  
598 outcome constitutes a *secondary* contact-line pinning that can, as a result, cause

599 premature bubble detachment from the surface (in contrast to the clean departure seen  
600 in Fig. 12(b)). Therefore, the pinned-contact-line description by Eq. (10) can to a  
601 certain degree still apply below  $P^*$  in Fig. 13(a) and 13(b).

602 The trapped vapor inside the cavity, we should again emphasize, is indispensable to  
603 uninterrupted cycles of bubble regeneration and growth. In Fig. 15 we map the  
604 occurrence of residual vapor over a grid defined by the cavity depth  $z$  and the reduced  
605 pressure  $P/P^*$  (with a maximum measurement uncertainty  $<2\%$ ), based on a thorough  
606 analysis of the high-speed images. As the results show, for the flat biphilic surface ( $z=0$ ),  
607 the observed instances (black circle) where the hydrophobic spot was covered in vapor  
608 at the end of the last cycle of ebullition are all limited to  $P > P^*$ . On the other hand,  
609 residual vapor has been found to exist on the cavity-structured surfaces even at  
610 pressures noticeably below  $P^*$ . That leads us to conclude that, it is through creating  
611 more stable nucleation sites—which can reliably remain active by resisting flooding—  
612 that boiling heat transfer was substantially enhanced on the dimpled biphilic surface at  
613 low-pressure conditions (as evidenced in Fig. 7). It should also be noted, nevertheless,  
614 that at exceptionally lower pressures, even the hydrophobic-coated cavities would  
615 become vulnerable to inevitable flooding (marked by gray triangle), which might  
616 explain, for instance, the markedly reduced potency of the surface when pressure was  
617 lowered to  $P=7.8$  kPa in Fig. 6.

618 **5. Conclusions**

619 In this paper, we have investigated saturated boiling on the surfaces with spatially  
620 superimposed wettability patterns and dimple structures under strongly subatmospheric  
621 conditions. Compared with the flat copper surface with the same biphilic pattern, the  
622 surface with an array of circular PTFE-coated cavities showed remarkably higher heat  
623 transfer rates, at least down to the pressure  $P=9.5$  kPa. However, the boiling  
624 enhancement was found to be nearly exhausted when the pressure was further reduced.  
625 The limited heat transfer enhancement was attributed to the apparently improved  
626 capacity of vapor traps that were created by the hydrophobic cavities. The high-speed  
627 visualization of the bubble departure dynamics revealed that compared with the flat  
628 surface, significantly more vapor residues were retained by the dimpled biphilic surface  
629 immediately after bubble departure, which facilitates continuous ebullition cycles with  
630 zero waiting time and is vital to achieve higher heat transfer coefficient. Moreover, for  
631 the dimpled biphilic surface, the varying bubble departure diameter with decreasing  
632 pressure exhibited a somewhat delayed transition to a regime dominated by contact line  
633 depinning. Such interesting findings suggest that the bubble detachment could entail a  
634 complicated process of secondary pinning of contact line inside the hydrophobic cavity.  
635 The mapping of the vapor trapping behavior showed the pressure limit was effectively  
636 reduced thanks to the dimpled biphilic surface. A worthwhile future extension of the  
637 current effort might include exploration of the possibility of building even stronger traps

638 for vapor using more elaborate cavity geometry and/or superhydrophobic coatings.  
639 Furthermore, a more informed understanding of the complex contact line dynamics—  
640 which can only be provided by direct experimental access to the contact-line region—  
641 would certainly beget new insights with regard to how to completely eliminate boiling  
642 deteriorations under declining pressures.

643

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777

778 **Table captions**

779 Table 1 Thermophysical properties of water at different pressures [48]

780 **Figure captions**

781 Figure 1 Schematic illustration of the boiling test setup

782 Figure 2 Test surface used in the present study: (a) fabrication of the dimpled biphilic surface; (b)  
783 photograph of the surface showing an unstaggered array of uniform cavities (yellow bar: 10 mm); and (c)  
784 digital microscope images of the uncoated and coated cavity bottom walls (yellow bars: 200  $\mu\text{m}$ )

785 Figure 3 Boiling curves for the plain copper surface at different pressures  $P=101.3$  kPa and 9.1 kPa

786 Figure 4 Boiling curves for the biphilic surface without dimple cavities at different pressures  $P=14.3$  kPa, 9.5  
787 kPa, and 7.8 kPa

788 Figure 5 Heat transfer enhancement ratio  $h/h_R$  of the flat biphilic surface under low pressures of  $P=14.3$   
789 kPa, 9.5 kPa, and 7.8 kPa.

790 Figure 6 Boiling curves for the biphilic surface with dimple cavities at different pressures  $P=14.4$  kPa, 9.5  
791 kPa, and 7.8 kPa

792 Figure 7 Heat transfer enhancement ratio  $h/h_R$  of the dimpled biphilic surface under low pressures of  
793  $P=14.4$  kPa, 9.5 kPa, and 7.8 kPa

794 Figure 8 Test surface used for visualization of bubble dynamics. (a) The surface was comprised of two  
795 dimple cavities (yellow bar: 10 mm), and (b) the insides of the cavities of different depths were coated by  
796 hydrophobic PTFE coatings

797 Figure 9 High-speed images depicting bubble departure ( $\Delta T_{sat}=7.9$  K) from the flat surface coated with a  
798 single hydrophobic spot with diameter  $L=1.8$  mm, at (a)  $P=100.8$  kPa and (b)  $P=25.3$  kPa



799 Figure 10 High-speed images depicting bubble departure ( $\Delta T_{sat}=8.4$  K) from the surface fabricated with two  
800 hydrophobic-coated  $\varnothing 1.8$ -mm cavities with various depths  $z_1=1.0$  mm and  $z_2=0.5$  mm, at (a)  $P=101.4$  kPa  
801 and (b)  $P=25.4$  kPa

802 Figure 11 Measurements of the bubble departure diameter  $D_b$  as a function of pressure from the  
803 hydrophobic spot (1.8 mm in diameter) on the flat surface of superheat  $\Delta T_{sat}=7.9$  K

804 Figure 12 Bubble departure from the flat biphilic surface with (a) pinned contact line and (b) depinned  
805 contact line

806 Figure 13 Measurements of the bubble departure diameter  $D_b$  as a function of pressure from the  
807 hydrophobic-coated  $\varnothing 1.8$ -mm cavities with various depths, (a)  $z_1=1.0$  mm and (b)  $z_2=0.5$  mm, under the  
808 superheat  $\Delta T_{sat}=8.4$  K

809 Figure 14 Bubble departure from the dimpled biphilic surface under (a) contact-line pinning and (b)  
810 secondary contact-line pinning

811 Figure 15 Effect of hydrophobic dimple structures to trap residual vapor after bubble departure. The  
812 horizontal axis represents the cavity depth, and the vertical axis the reduced pressure  $P/P^*$

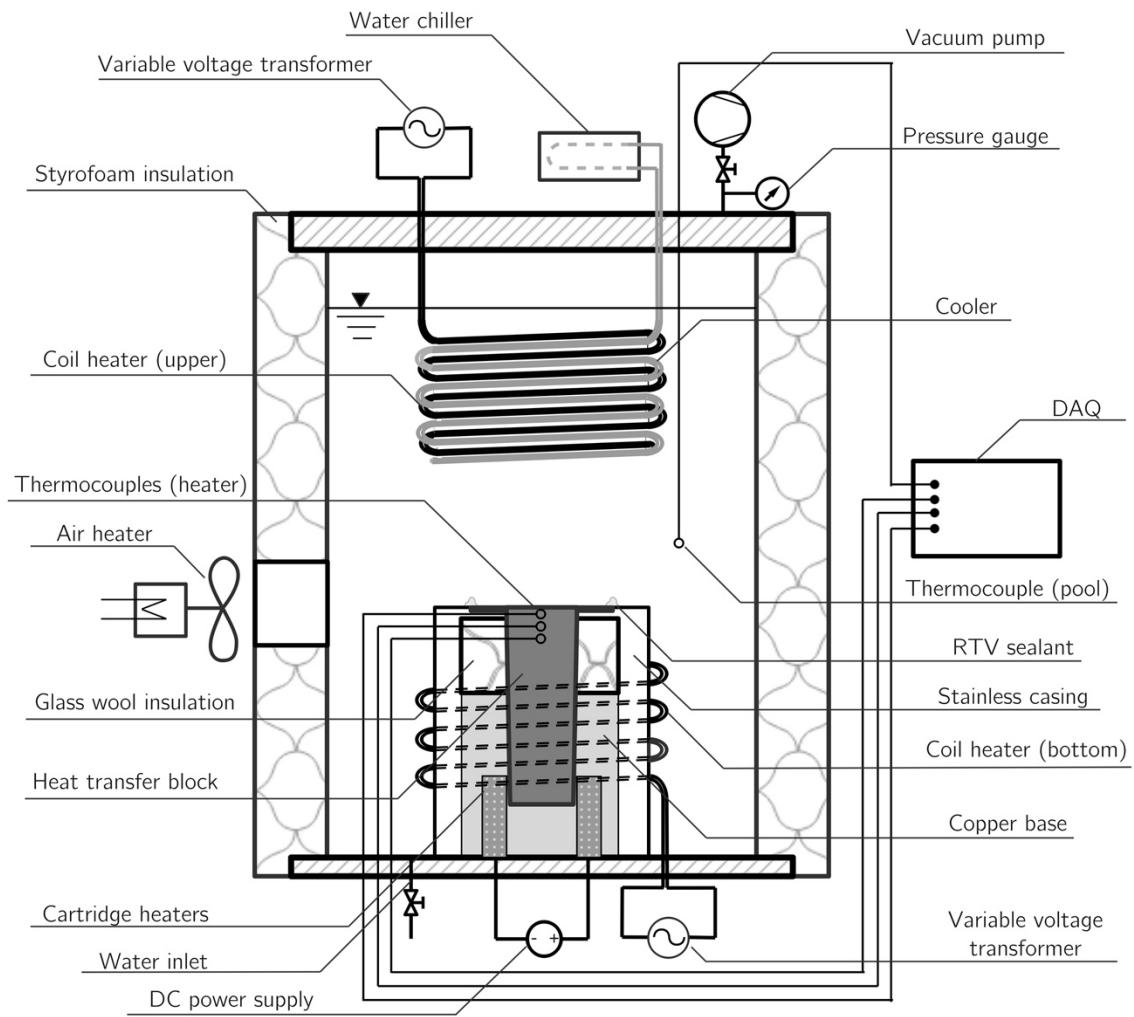
813 Figure S1 Measurement uncertainties (@68% confidence level) for the heat flux  $q$ , surface superheat  $\Delta T_{sat}$ ,  
814 and heat transfer coefficient  $h$

815

816 Table 1 Thermophysical properties of water at different pressures [48]

$P_{sat}$	$T_{sat}$	$\lambda_l$	$\rho_l$	$\rho_v$	$h_{lv}$	$\mu_l$	$\sigma$	$c_{p,l}$	Pr <sub>l</sub>
(kPa)	(°C)	(W/m K)	(kg/m <sup>3</sup> )	(kg/m <sup>3</sup> )	(kJ/kg)	(μPa s)	(mN/m)	(kJ/kg K)	(-)
101.3	100.0	0.679	958.37	0.5977	2256.44	281.8	58.917	4.2156	1.75
14.3	53.0	0.647	986.62	0.0954	2374.68	520.6	67.441	4.1825	3.37
9.5	44.8	0.637	990.25	0.0650	2394.47	598.1	68.809	4.1803	3.92
7.8	41.0	0.632	991.78	0.0540	2403.46	640.5	69.429	4.1798	4.24

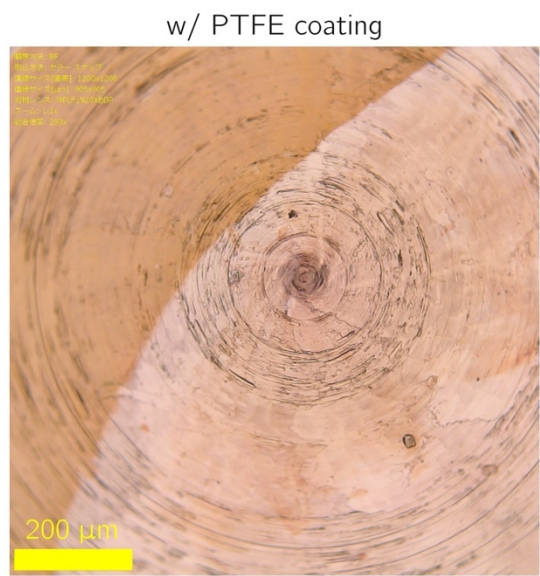
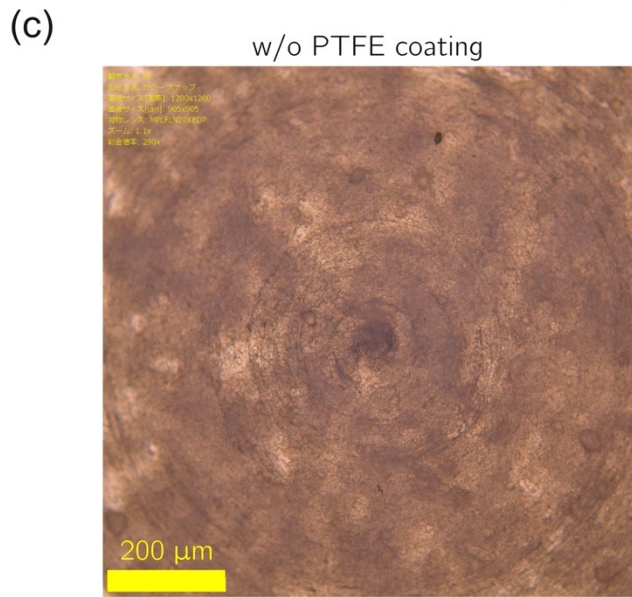
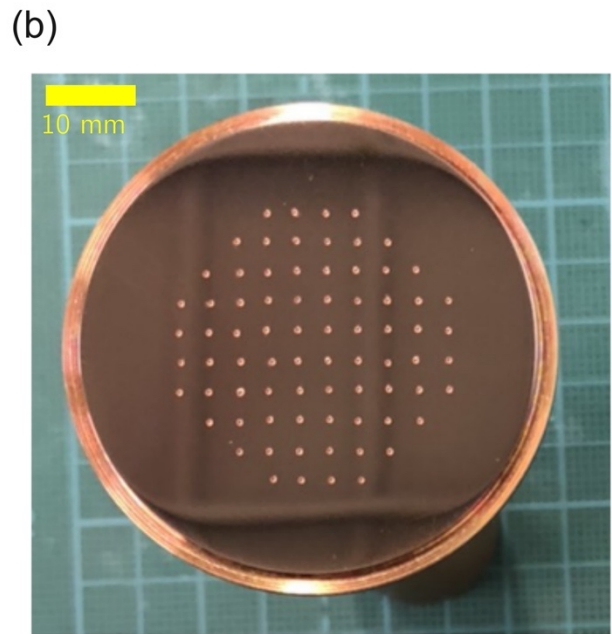
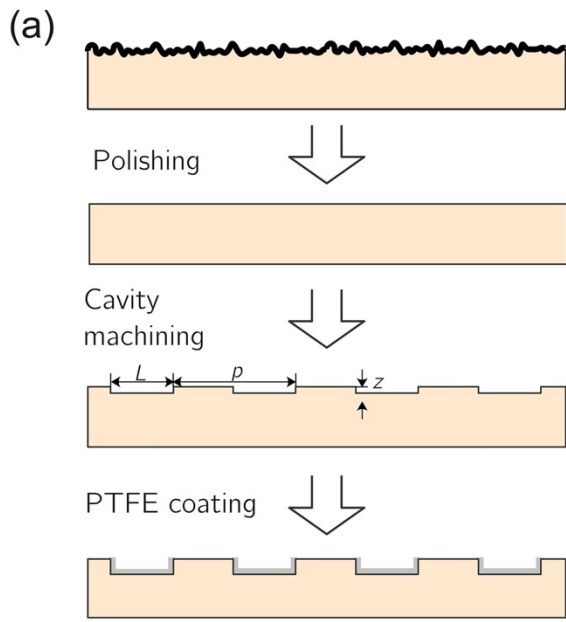
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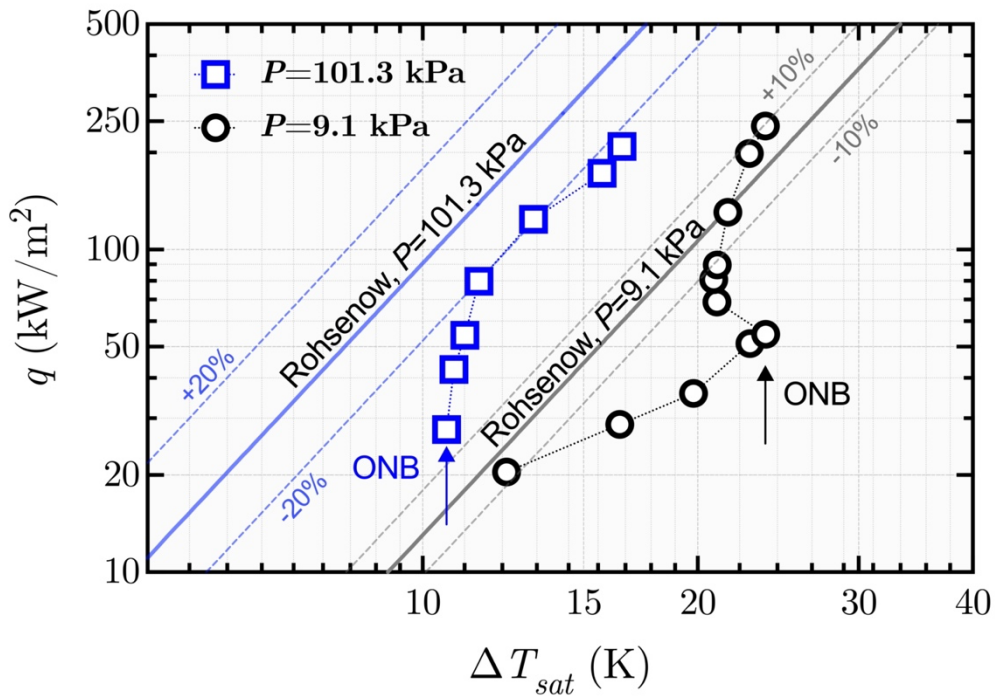
Fig. 1



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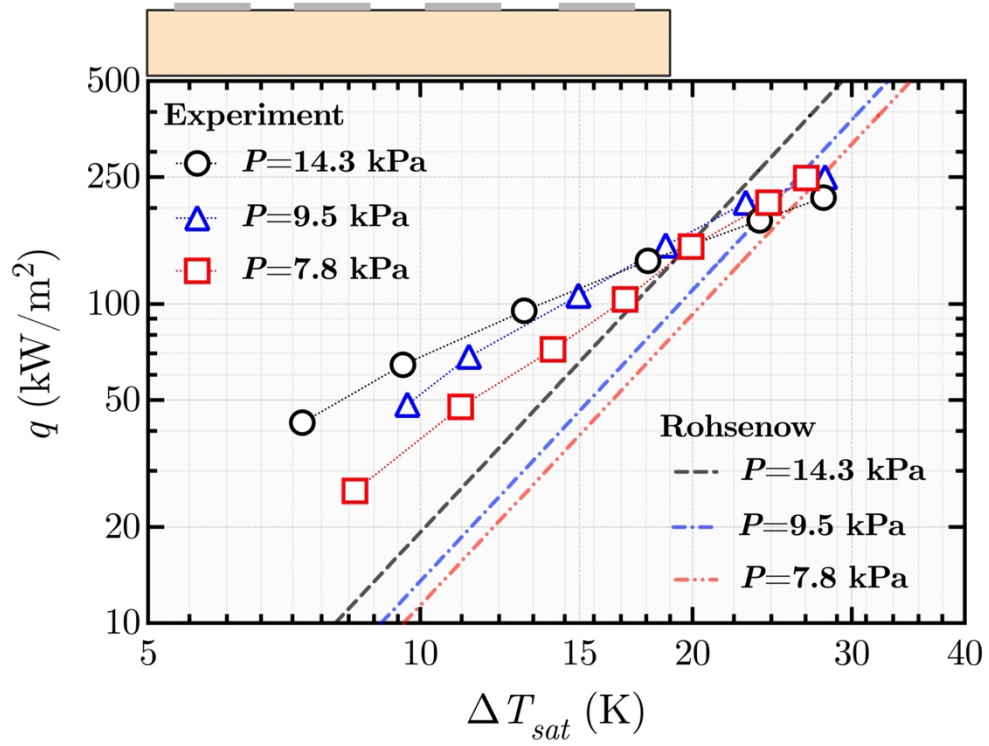
Fig. 2



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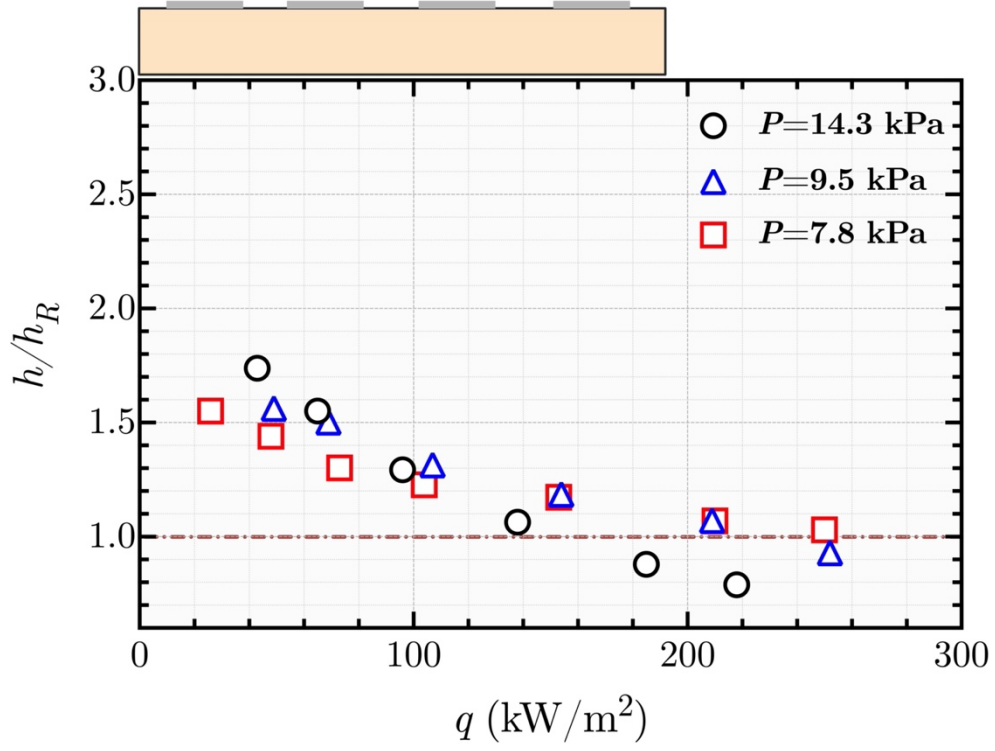
Fig. 3



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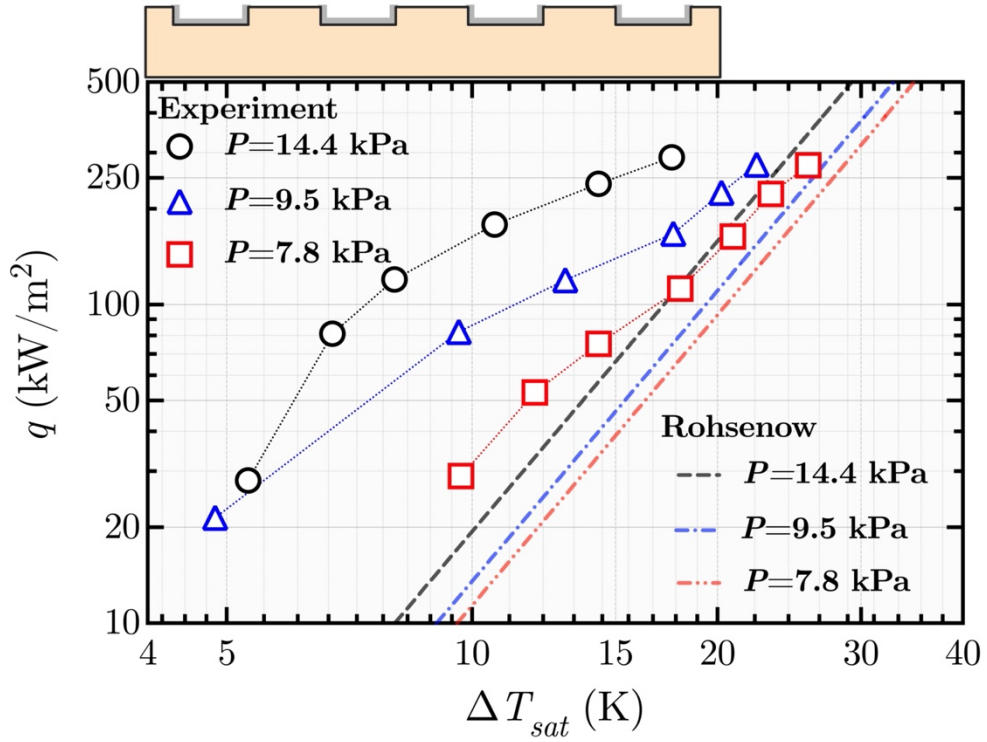
Fig. 4



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Fig. 5

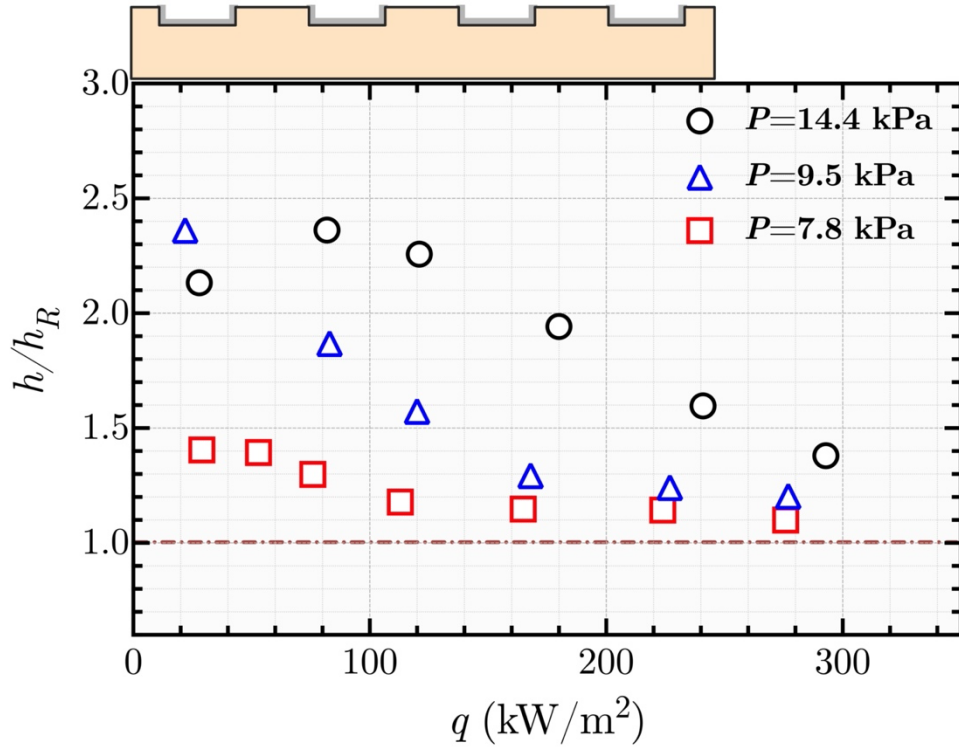


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Fig. 6



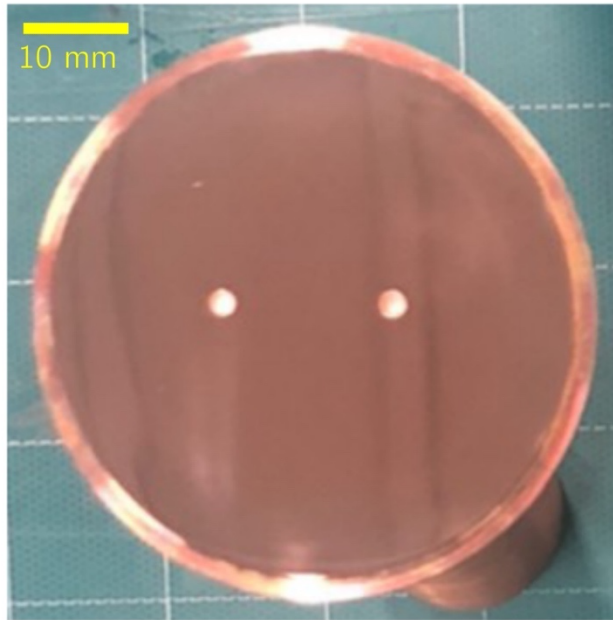


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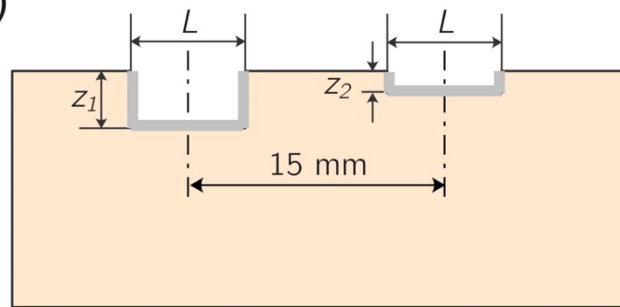
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Fig. 7

(a)



(b)



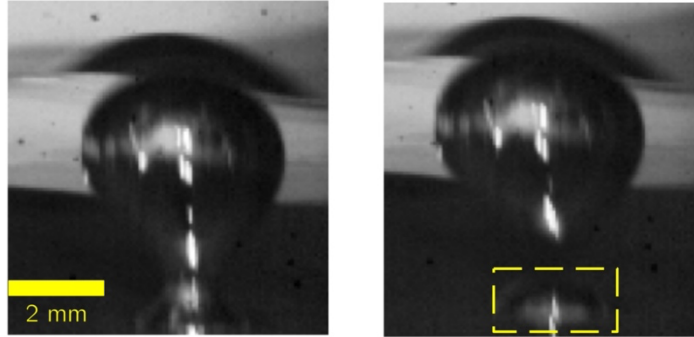
— PTFE coating

832

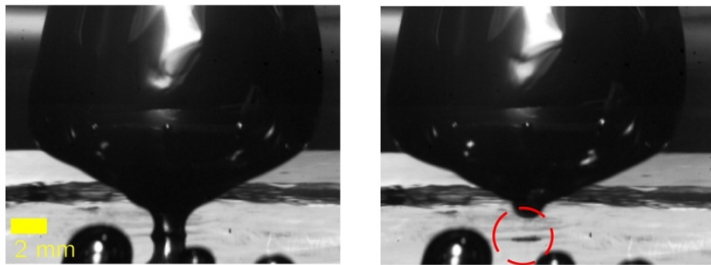
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Fig. 8

(a)  $P=100.8$  kPa



(b)  $P=25.3$  kPa



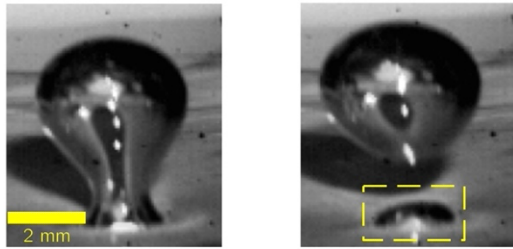
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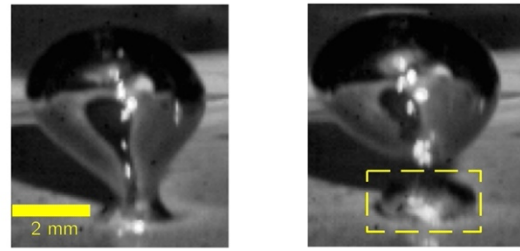
Fig. 9

(a)  $P=101.4$  kPa

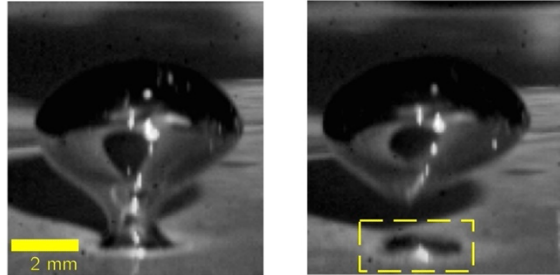
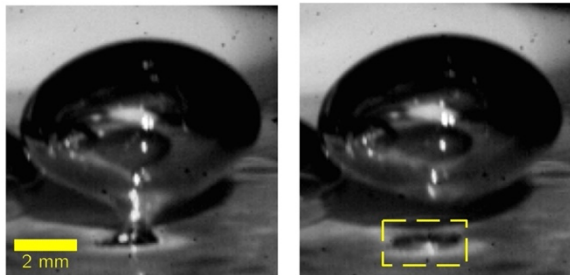
$z_1=1.0$  mm



$z_2=0.5$  mm



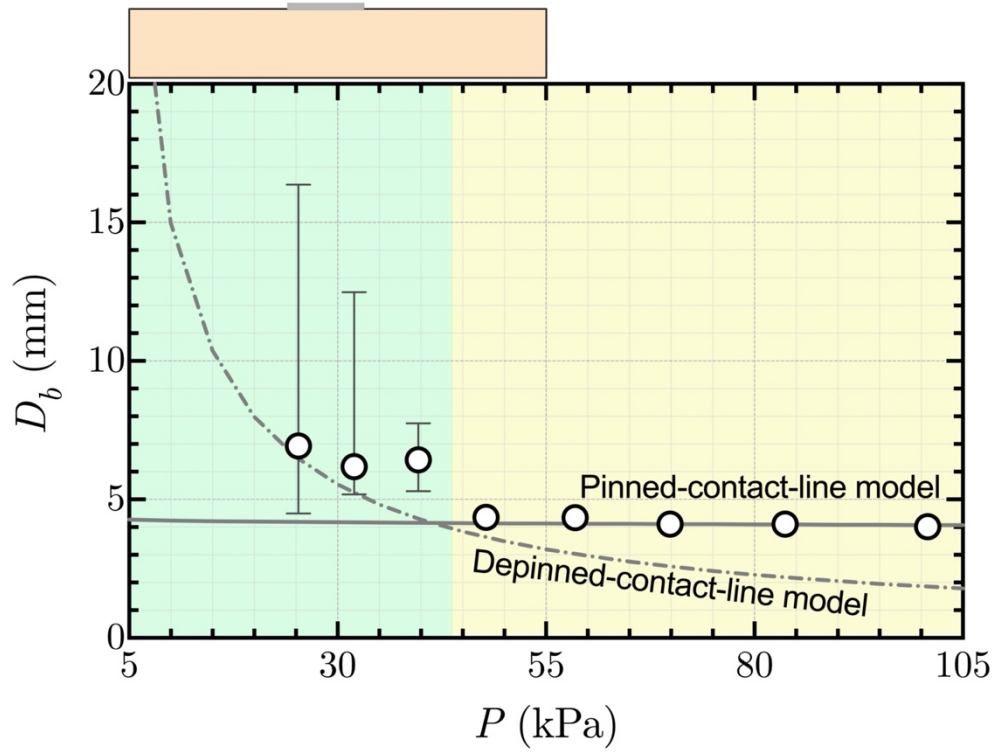
(b)  $P=25.4$  kPa



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837

Fig. 10

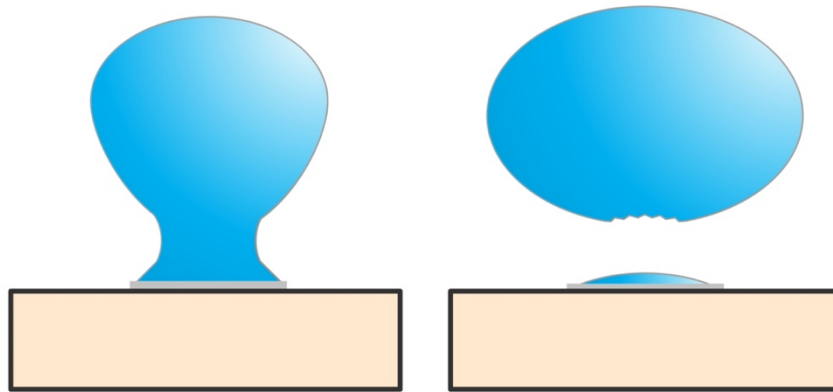


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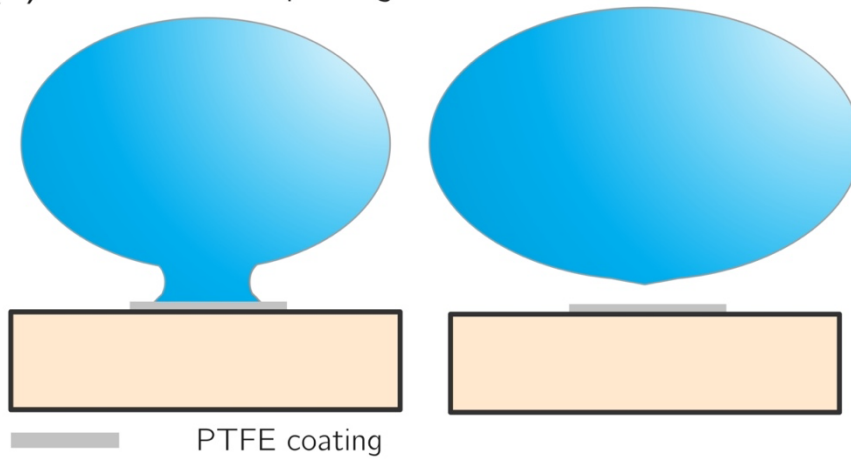
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Fig. 11

(a) Contact-line pinning



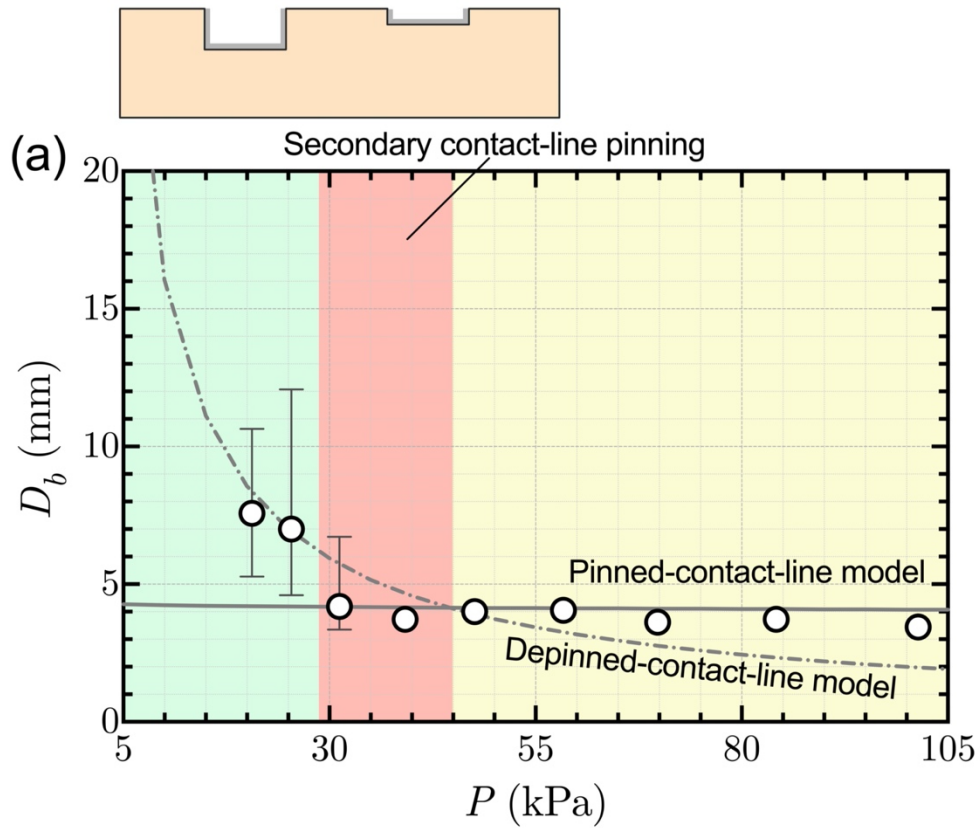
(b) Contact-line depinning



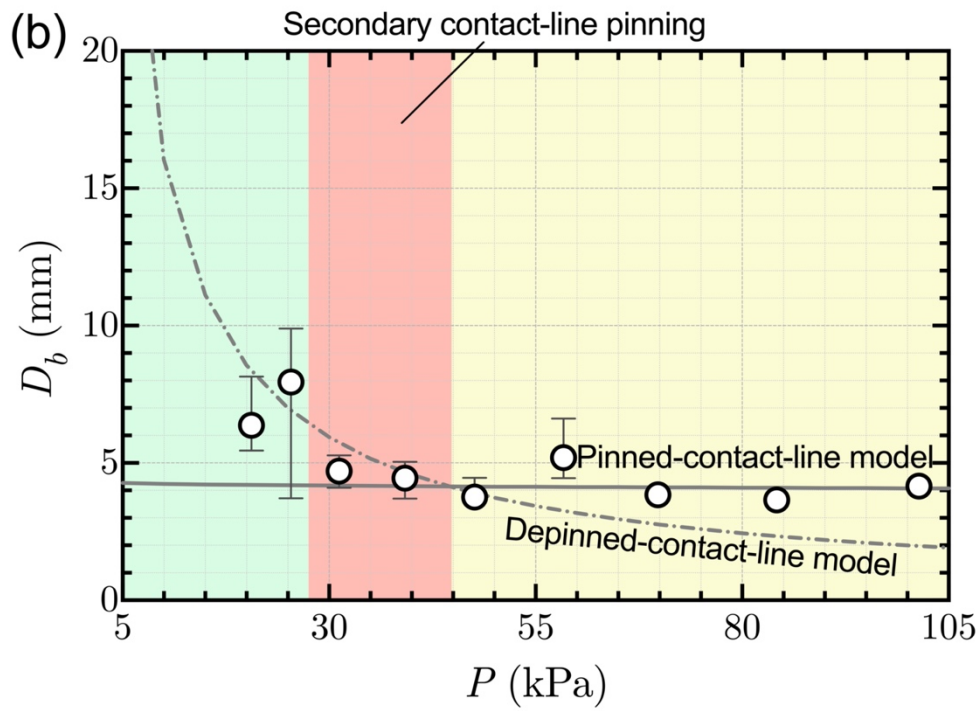
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841

Fig. 12



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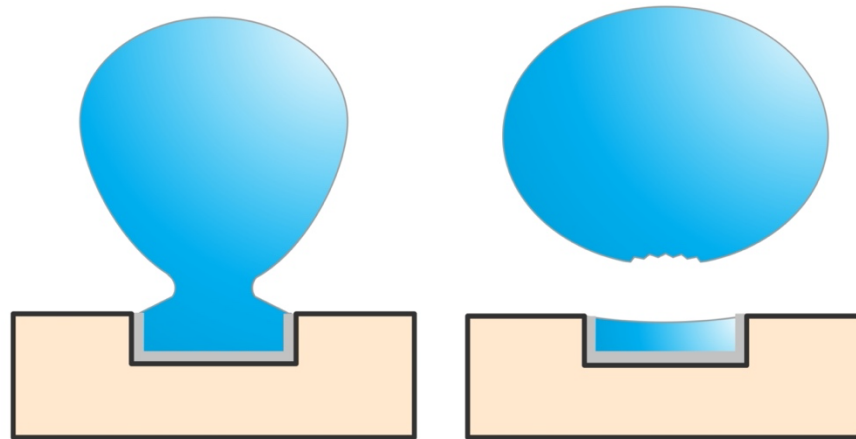


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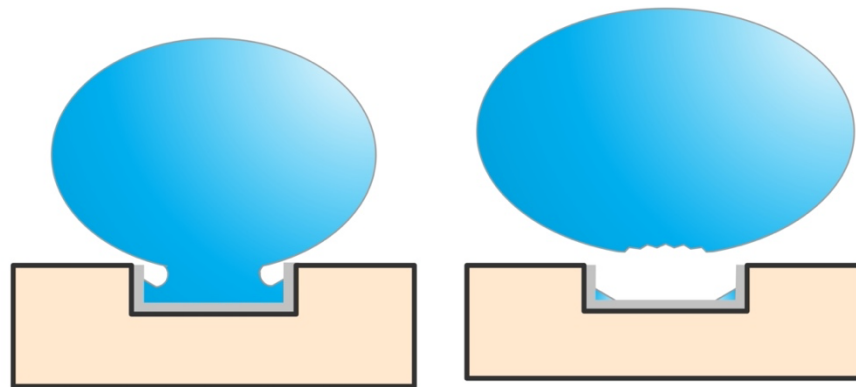
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Fig. 13

(a) Contact-line pinning



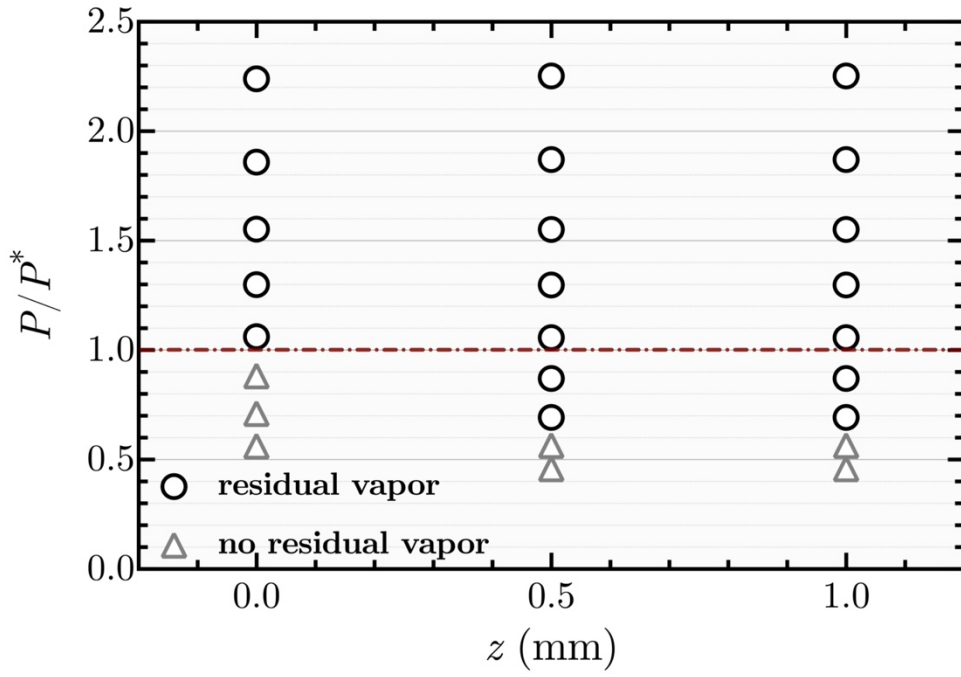
(b) Secondary contact-line pinning



PTFE coating

Fig. 14





848

849

Fig. 15

850 **Supplemental Material**

851 **Limited Enhancement of Subatmospheric Boiling on Treated**

852 **Structured Surfaces with Biphilic Pattern**

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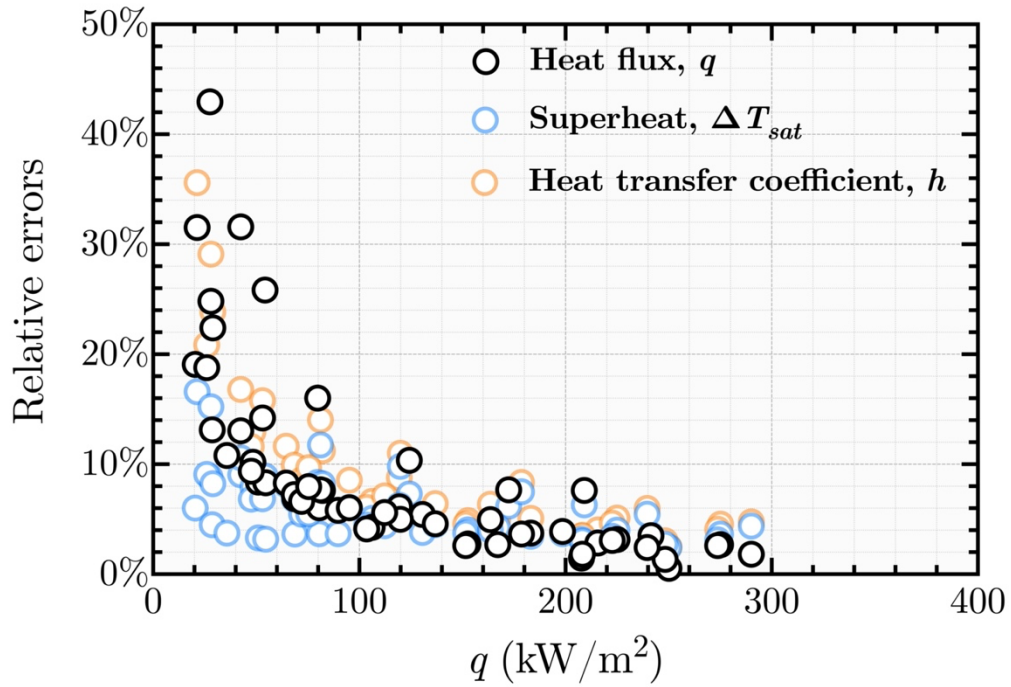
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881 The measurement uncertainties for surface superheat  $\Delta T_{sat}$ , heat flux  $q$ , and heat  
882 transfer coefficient  $h$  in the present study are shown in Fig. S1.



883  
884 Figure S1 Measurement uncertainties (@68% confidence level) for the heat flux  $q$ , surface superheat  $\Delta T_{sat}$ ,  
885 and heat transfer coefficient  $h$